Notice of Allowability	Application No.	Applicant(s)	
	10/799,062	HARVEY N. ROGERS ET AL.	
	Examiner	Art Unit	
	Jasmine J. Clark	2815	
The MAILING DATE of this communication appears on the cover sheet with the correspondence address All claims being allowable, PROSECUTION ON THE MERITS IS (OR REMAINS) CLOSED in this application. If not included herewith (or previously mailed), a Notice of Allowance (PTOL-85) or other appropriate communication will be mailed in due course. THIS NOTICE OF ALLOWABILITY IS NOT A GRANT OF PATENT RIGHTS. This application is subject to withdrawal from issue at the initiative of the Office or upon petition by the applicant. See 37 CFR 1.313 and MPEP 1308.			
1. This communication is responsive to			
2. The allowed claim(s) is/are <u>1-8</u> .			
3. The drawings filed on 11 March 2004 are accepted by the Examiner.			
 4.			
each sheet. Replacement sheet(s) should be labeled as such in the header according to 37 CFR 1.121(d). 7. DEPOSIT OF and/or INFORMATION about the deposit of BIOLOGICAL MATERIAL must be submitted. Note the attached Examiner's comment regarding REQUIREMENT FOR THE DEPOSIT OF BIOLOGICAL MATERIAL.			
Attachment(s) 1. ☑ Notice of References Cited (PTO-892) 2. ☐ Notice of Draftperson's Patent Drawing Review (PTO-948) 3. ☐ Information Disclosure Statements (PTO-1449 or PTO/SB/C Paper No./Mail Date 4. ☐ Examiner's Comment Regarding Requirement for Deposit of Biological Material	5. Notice of Informal P 6. Interview Summary Paper No./Mail Dat 7. Examiner's Amendr 8. Examiner's Stateme 9. Other	(PTO-413), le nent/Comment	

DETAILED ACTION

1. This application was searched, in class 257, subclasses 774, 775, 750, 758, and 759 (stress with buffer), in view of the disclosure here. This search was ineffective.

References Cited

2. Gnadinger (US 5,229,647), Akarm et al. (US 6,002,180), Wong (US 6,300,688 B1), McMahon (US 6,075,712), and Anand (US 6,362,528 B2) teaches relating a semiconductor device including a plurality via bonding pads; but fails to teach including a stress relief buffer for absorbing any strain produced by differences in thermal expansion between a semiconductor chip and a metal carrier and the limitations as set forth in the claimed invention (see limitation sin claims 1 and 8).

Allowable Subject Matter

3. Claim³ 8 are allowed.

The following is an examiner's statement of reasons for allowance: please see paragraph 2 above.

Any comments considered necessary by applicant must be submitted no later than the payment of the issue fee and, to avoid processing delays, should preferably accompany the issue fee. Such submissions should be clearly labeled "Comments on Statement of Reasons for Allowance."

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Telephone Inquiry Contacts

4. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Jasmine J. Clark whose telephone number is (571) 272-1726. The examiner can normally be reached on Flex.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Tom Thomas can be reached on (571) 272-1664. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Jjbc/12/26/04

JASMINE CLARK PRIMARY EXAMINER

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